STW3N170, STWA3N170

N-channel 1700 V, 7 Ω typ., 2.6 A PowerMESH™ Power MOSFETs in TO-247 and TO-247 long leads packages

Datasheet - production data

TO-247   TO-247 long leads
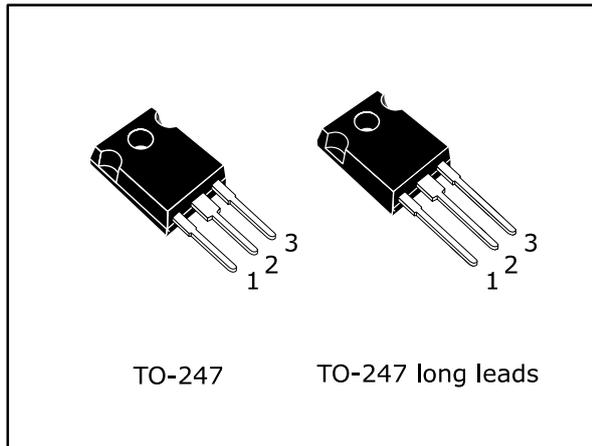
**Figure 1: Internal schematic diagram**

NG1D2S3

Features

Order code	V_{DS}	$R_{DS(on)}$ max.	I_D	P_{TOT}
STW3N170	1700 V	13 Ω	2.6 A	160 W
STWA3N170				

- Intrinsic capacitances and Q_g minimized
- High speed switching
- 100% avalanche tested

Applications

- Switching applications

Description

This Power MOSFET is designed using the STMicroelectronics consolidated strip-layout-based MESH OVERLAY™ process. The result is a product that matches or improves on the performance of comparable standard parts from other manufacturers.

Table 1: Device summary

Order code	Marking	Package	Packing
STW3N170	3N170	TO-247	Tube
STWA3N170		TO-247 long leads	

Contents

1   Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	1700	V
V_{GS}	Gate-source voltage	±30	V
I_D	Drain current (continuous) at T_{case} = 25 °C	2.6	A
	Drain current (continuous) at T_{case} = 100 °C	1.6	
I_{DM}[1]	Drain current (pulsed)	10.4	A
P_{TOT}	Total dissipation at T_{case} = 25 °C	160	W
I_{AR}	Avalanche current, repetitive or not repetitive	0.8	A
E_{AS}[2]	Single pulse avalanche energy	2	mJ
T_{stg}	Storage temperature	-55 to 150	°C
T_j	Operating junction temperature		

Notes:

[1] Pulse width limited by T_{jmax}.

[2] starting T_j = 25 °C, I_D = I_{AR}, V_{DD} = 50 V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	0.78	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient	50	

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	1700			V
I_{DSS}	Zero gate voltage drain current	V_{GS} = 0 V, V_{DS} = 1700 V			10	µA
		V_{GS} = 0 V, V_{DS} = 1700 V, T_{case} = 125 °C			500	
I_{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±30 V			±100	nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 250 µA	3	4	5	V
$R_{DS(on)}$	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 1.3 A		7	13	Ω

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0 V	-	1100	-	pF
C_{oss}	Output capacitance		-	50	-	
C_{rss}	Reverse transfer capacitance		-	7	-	
R_G	Intrinsic gate resistance	f = 1 MHz, I_D = 0 A	-	3.6	-	Ω
Q_g	Total gate charge	V_{DD} = 1360 V, I_D = 2.6 A, V_{GS} = 10 V (see *Figure 15: "Test circuit for gate charge behavior"*)	-	44	-	nC
Q_{gs}	Gate-source charge		-	7	-	
Q_{gd}	Gate-drain charge		-	25	-	

Table 6: Switching times

| Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	V_{DD} = 850 V, I_D = 1.3 A R_G = 4.7 Ω, V_{GS} = 10 V (see *Figure 14: "Test circuit for resistive load switching times"* and *Figure 19: "Switching time waveform"*)	-	25	-	ns
t_r	Rise time		-	9	-	
$t_{d(off)}$	Turn-off delay time		-	51	-	
t_f	Fall time		-	53	-	

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current	$T_j = 25\ °C$	-		2.6	A
I_{SDM}	Source-drain current (pulsed)	$T_j = 25\ °C$	-		10.4	A
V_{SD}[(1)]	Forward on voltage	$V_{GS} = 0\ V$, $I_{SD} = 2.6\ A$	-		1.5	V
t_{rr}	Reverse recovery time	$I_{SD} = 2.6\ A$, di/dt = 100 A/µs, $V_{DD} = 60\ V$ (see *Figure 16: "Test circuit for inductive load switching and diode recovery times"*)	-	1.58		µs
Q_{rr}	Reverse recovery charge		-	6		µC
I_{RRM}	Reverse recovery current		-	7.9		A
t_{rr}	Reverse recovery time	$I_{SD} = 2.6\ A$, di/dt = 100 A/µs, $V_{DD} = 60\ V$, $T_j = 150\ °C$ (see *Figure 16: "Test circuit for inductive load switching and diode recovery times"*)	-	2.12		µs
Q_{rr}	Reverse recovery charge		-	8.8		µC
I_{RRM}	Reverse recovery current		-	8.3		A

Notes:

[(1)] Pulse test: pulse duration = 300 µs, duty cycle 1.5%.

2.1   Electrical characteristics (curves)

Figure 2: Safe operating area

Figure 3: Thermal impedance

Figure 4: Output characteristics

Figure 5: Transfer characteristics

Figure 6: Gate charge vs gate-source voltage

Figure 7: Static drain-source on-resistance
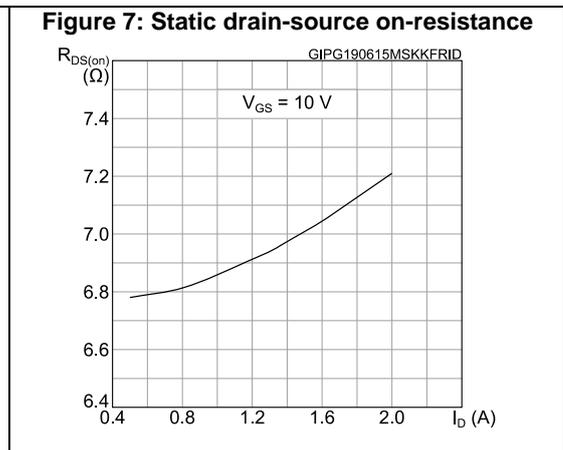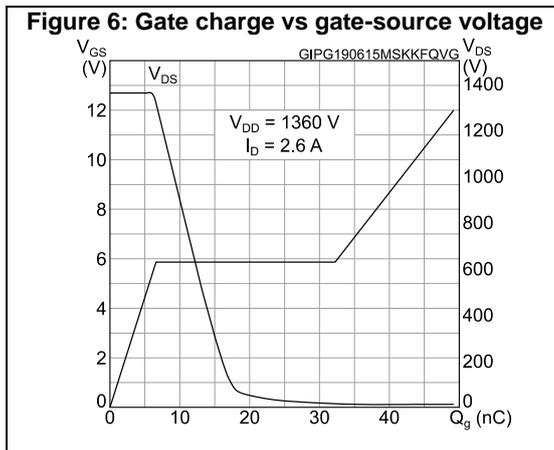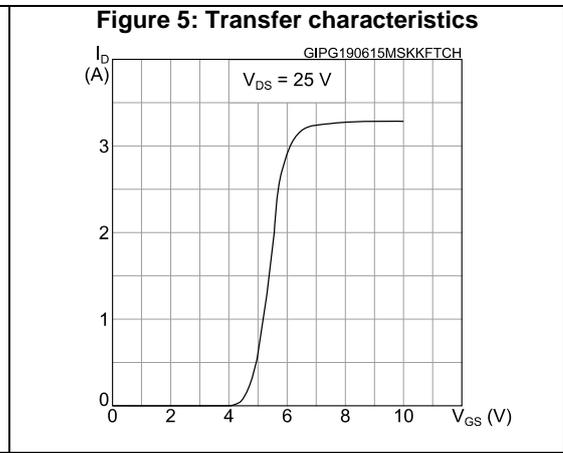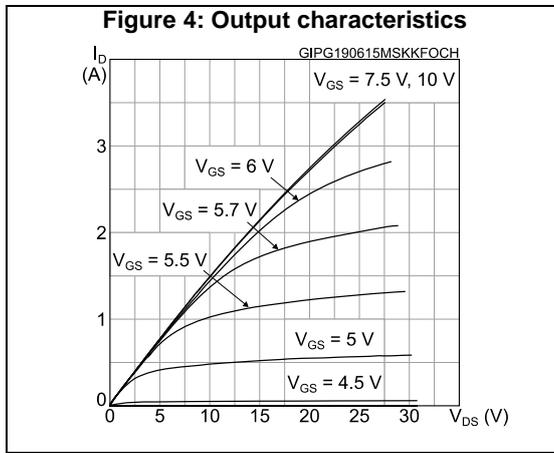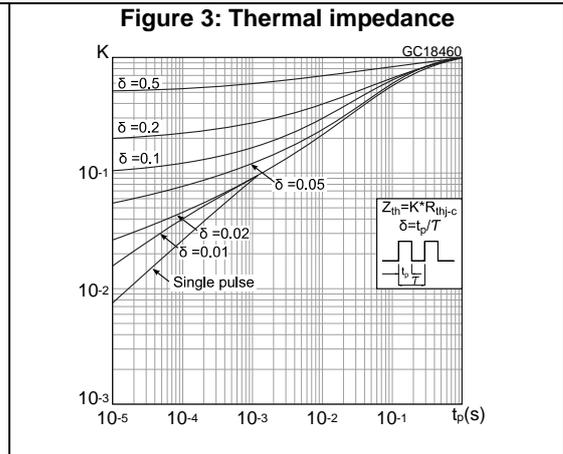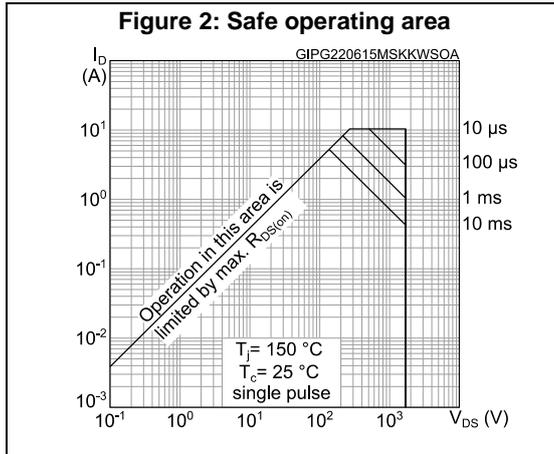
Figure 8: Capacitance variations
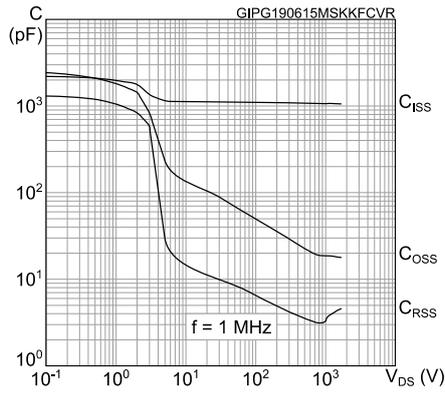
Figure 9: Normalized gate threshold voltage vs temperature
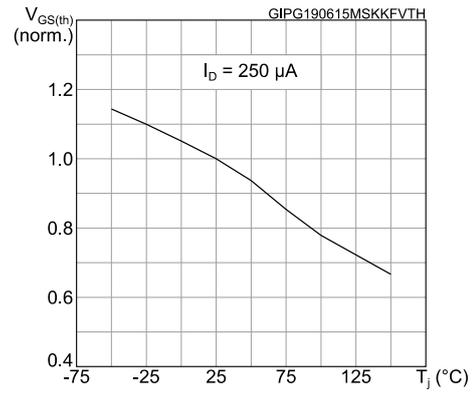
Figure 10: Normalized on-resistance vs temperature
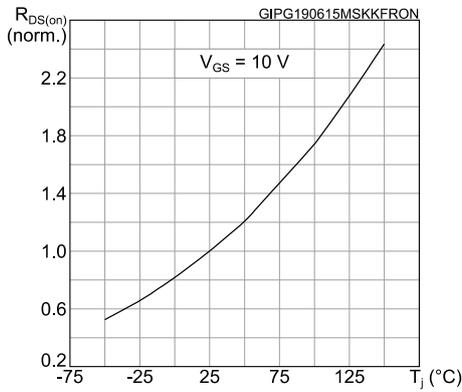
Figure 11: Normalized V(BR)DSS vs temperature
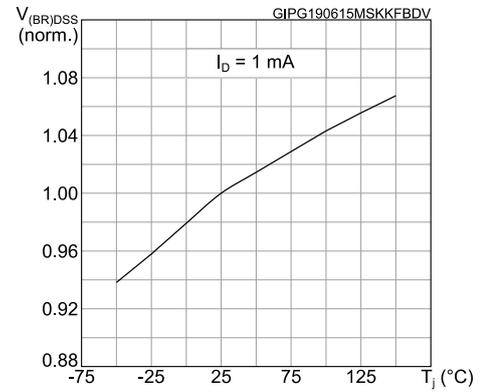
Figure 12: Output capacitance stored energy
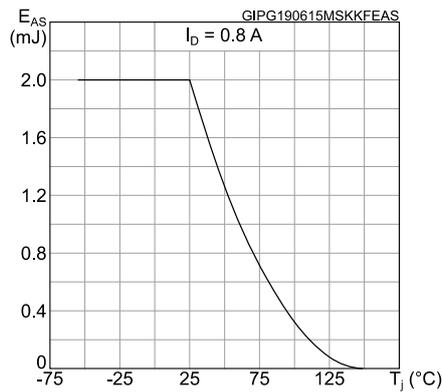
Figure 13: Source- drain diode forward characteristics
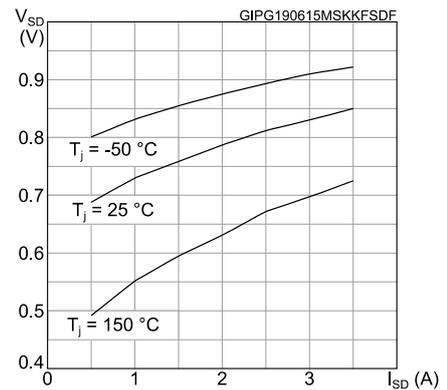
3 Test circuits

Figure 14: Test circuit for resistive load switching times
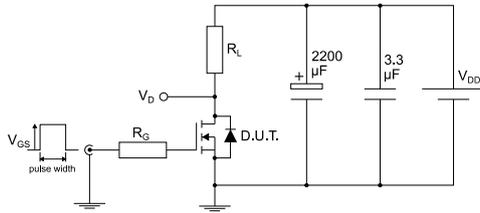
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**Figure 15: Test circuit for gate charge behavior**
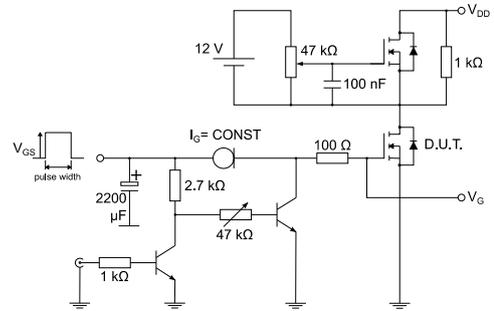
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Figure 16: Test circuit for inductive load switching and diode recovery times
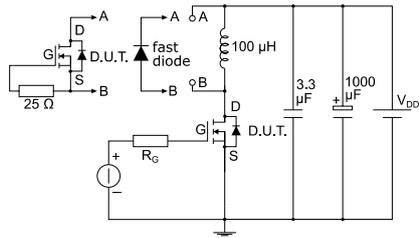
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Figure 17: Unclamped inductive load test circuit
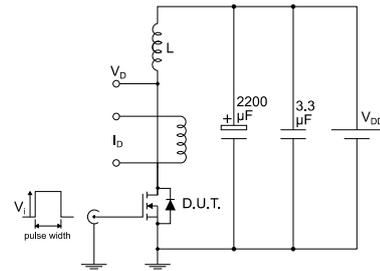
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Figure 18: Unclamped inductive waveform
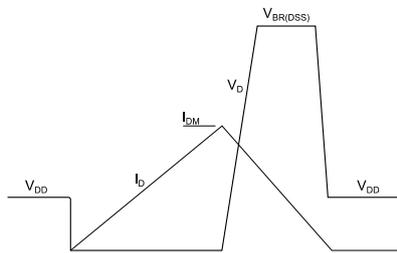
AM01472v1

Figure 19: Switching time waveform
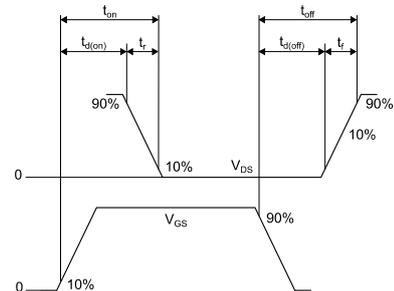
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK® is an ST trademark.

## 4.1 TO-247 package information

Figure 20: TO-247 package outline
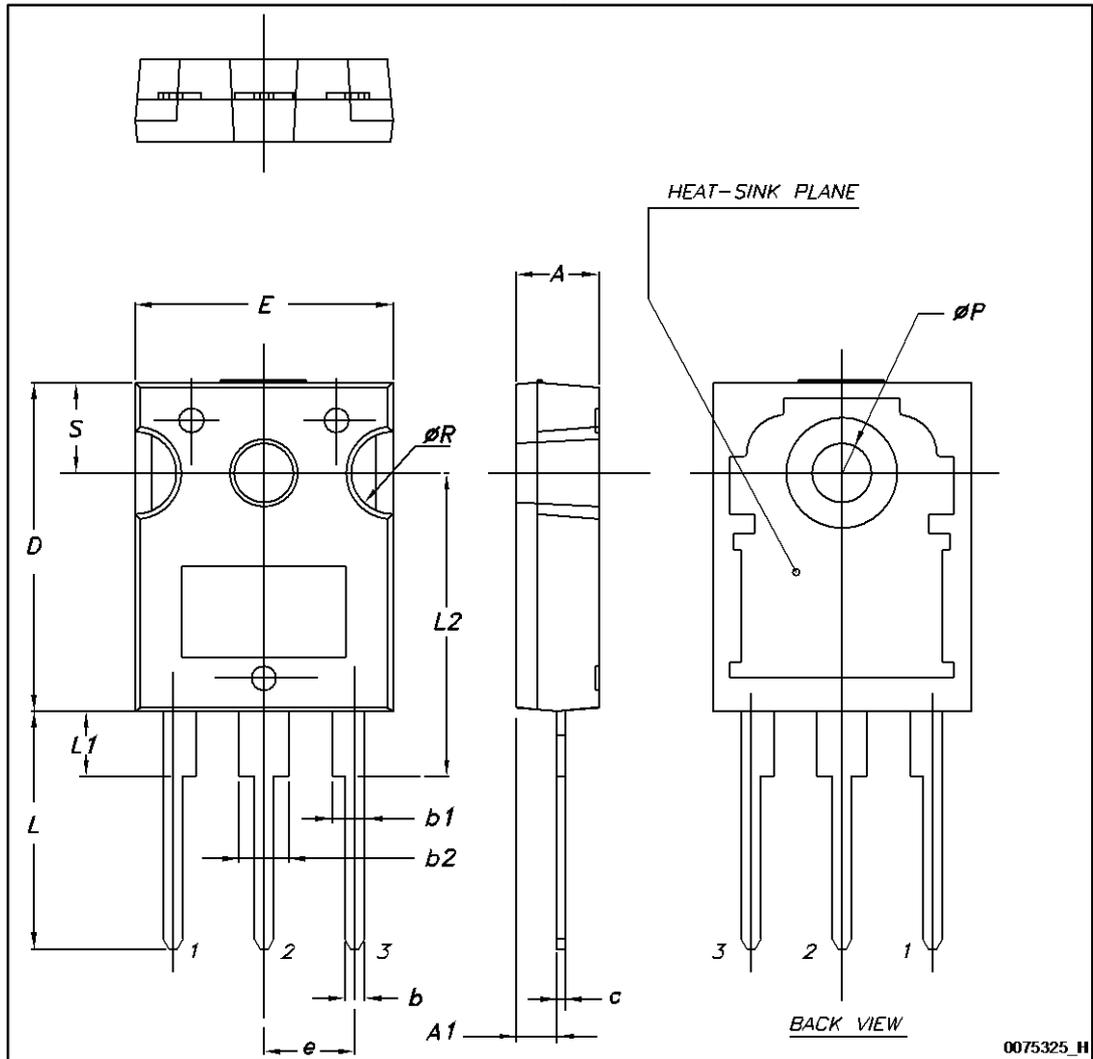
Table 8: TO-247 package mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

4.2   TO-247 long leads package information

Figure 21: TO-247 long leads package outline
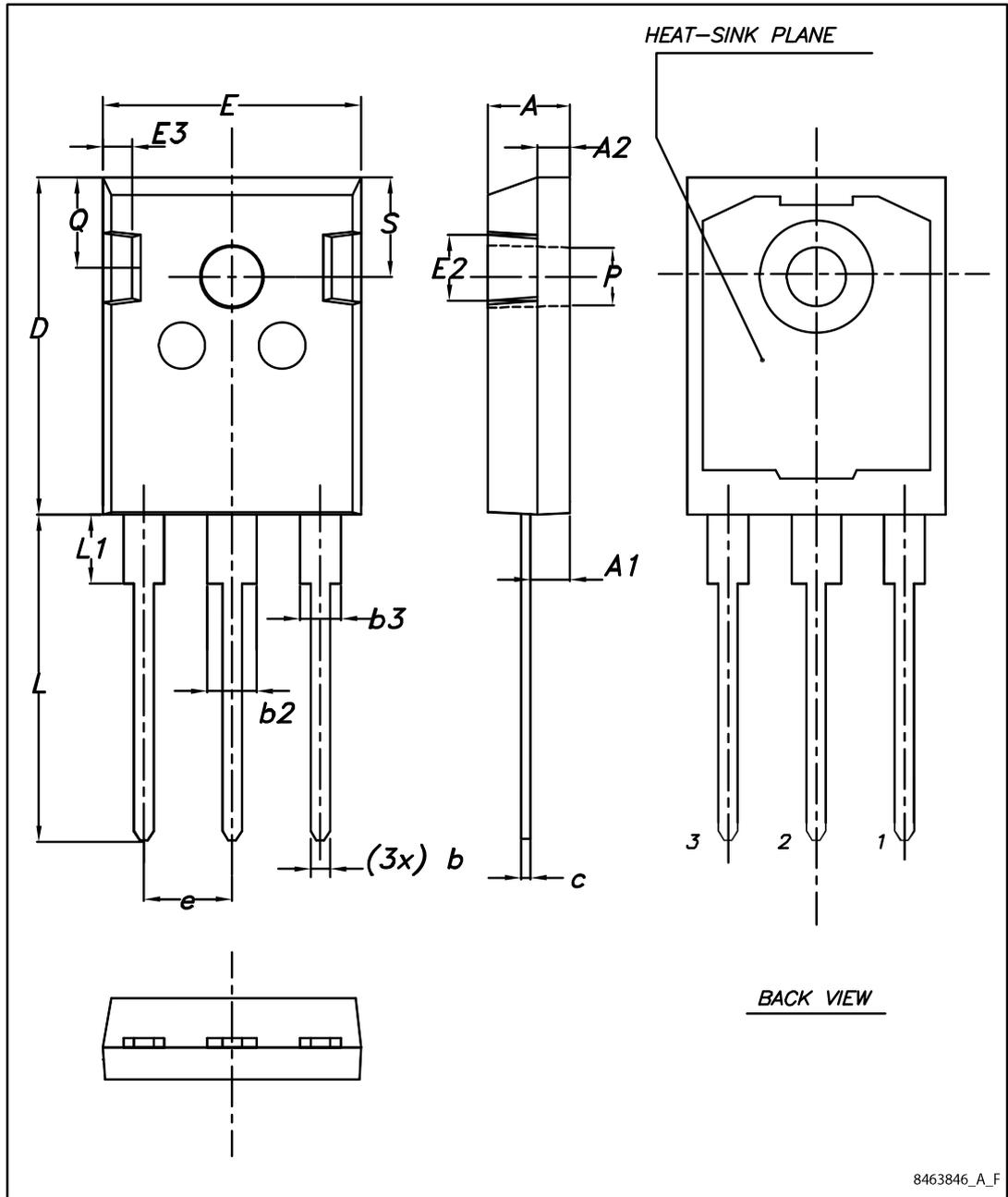
Table 9: TO-247 long leads package mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
14-Sep-2015	1	First release.

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